

Layer	Type	Material	Thickness	Constant	Board Layer	Stress
	Top Overlay					
	Top Solder	Solder Resist	0.5mil	3.8		
	Pre Layer					
	Dielectric 1	FR4 370	2.5mil			
	Signal Layer 1		11.5mil	4.2		
	Dielectric 2	FR4 370	30.5mil			
	Signal Layer 2		11.5mil			
	Dielectric 3	FR4 370	11.5mil	4.2		
	Bottom Layer					
	Bottom Solder	Solder Resist	0.5mil	3.8		
	Bottom Overlay					